



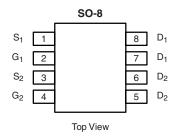
N- and P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	
N-Channel	30	0.025 at V _{GS} = 10 V	6.9	
		0.035 at V _{GS} = 4.5 V	5.8	
P-Channel	- 30	0.032 at V _{GS} = - 10 V	- 6.1	
		0.045 at V _{GS} = - 4.5 V	- 5.1	

FEATURES

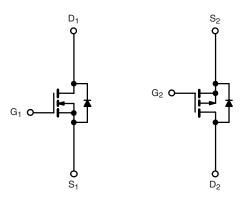
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC





Ordering Information: Si4542DY-T1-E3 (Lead (Pb)-free)

Si4542DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage		V_{DS}	30	- 30	V	
Gate-Source Voltage		V_{GS}	GS ± 20 ± 2] '	
Continuous Proin Current /T 150 °C\a	T _A = 25 °C	- I _D	6.9	- 6.1	^	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		5.5	- 4.9		
Pulsed Drain Current		I _{DM}	40	- 40	Α	
Continuous Source Current (Diode Conduction) ^a		I _S	1.7	- 1.7		
Mariana Barra Biraira da	T _A = 25 °C	P _D 2.0		.0	W	
Maximum Power Dissipation ^a	T _A = 70 °C	ט י	1.3			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	N- or P-Channel	Unit		
Maximum Junction-to-Ambient ^a	R _{thJA}	62.5	°C/W		

Notes:

a. Surface Mounted on FR4 board, $t \leq 10 \ s.$

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SPECIFICATIONS $T_J = 25$ °	SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit	
Static								
Gate Threshold Voltage	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	N-Ch	1.0			\/	
	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	P-Ch	- 1.0			V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	N-Ch			± 100	nA	
			P-Ch			± 100		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	N-Ch			1		
		V _{DS} = - 30 V, V _{GS} = 0 V	P-Ch			- 1	μΑ	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	N-Ch			25		
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	P-Ch			- 25		
On-State Drain Current ^a	l _{lac} ,	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	20			А	
	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	P-Ch	- 20				
		$V_{GS} = 10 \text{ V}, I_D = 6.9 \text{ A}$	N-Ch		0.020	0.025		
	D	V _{GS} = - 10 V, I _D = - 6.1 A	P-Ch		0.026	0.032		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 5.8 \text{ A}$	N-Ch		0.026	0.035	Ω	
		V _{GS} = - 4.5 V, I _D = - 5.1 A	P-Ch		0.036	0.045		
	_	V _{DS} = 15 V, I _D = 6.9 A	N-Ch		25			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 6.1 A	P-Ch		16		S	
	V _{SD}	I _S = 1.7 A, V _{GS} = 0 V	N-Ch			1.2	V	
Diode Forward Voltage ^a		I _S = - 1.7 A, V _{GS} = 0 V	P-Ch			- 1.2		
Dynamic ^b							•	
Total Gata Chargo	Q _g	N-Channel	N-Ch		30	50	nC	
Total Gate Charge			P-Ch		32	50		
Gate-Source Charge		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 6.9 \text{ A}$	N-Ch		7.5			
	ys	P-Channel	P-Ch		7.0			
Gate-Drain Charge	Q_{gd}	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -6.1 \text{ A}$	N-Ch		3.5			
	9-		P-Ch	0.5	5.0	0.4		
Gate Resistance	R_{g}		N-Ch P-Ch	0.5 2	2 4	3.4 6.8	Ω	
			N-Ch		12	20		
Turn-On Delay Time	t _{d(on)}	N-Channel V_{DD} = 15 V, R_L = 10 Ω	P-Ch		10	20		
			N-Ch		10	20		
Rise Time		$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$	P-Ch		10	20		
Tire Off Dolou Time	t _{d(off)}	P-Channel	N-Ch		60	90		
Turn-Off Delay Time		$V_{DD} = -15 \text{ V}, R_L = 10 \Omega$	P-Ch		55	80	ns -	
Fall Time	t _f	$I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 6 Ω	N-Ch		15	30		
			P-Ch		25	40		
Source-Drain	t _{rr}	I _F = 1.7 A, dl/dt = 100 A/μs	N-Ch		50	90		
Reverse Recovery Time		I _F = - 1.7 A, dl/dt = 100 A/μs	P-Ch		50	90		
Reverse Recovery Time	Q_{rr}	I _F = 1.7 A, dl/dt = 100 A/μs N-Ch			45		nC	
Tieverse Hecovery Time	11	I _F = - 1.7 A, dl/dt = 100 A/μs	P-Ch		55		110	

Notes:

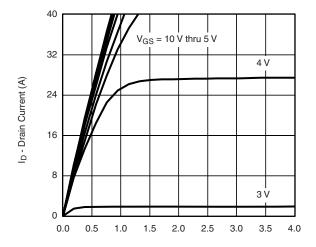
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



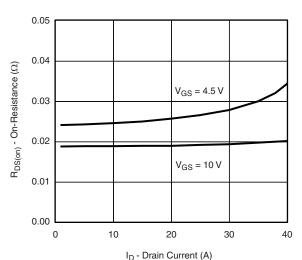


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless otherwise noted

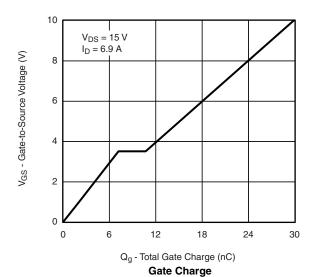


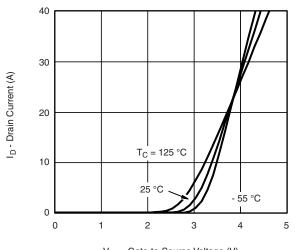
V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics



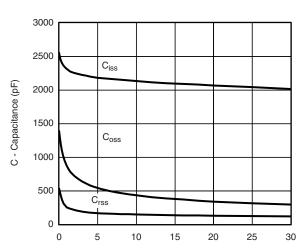
On-Resistance vs. Drain Current





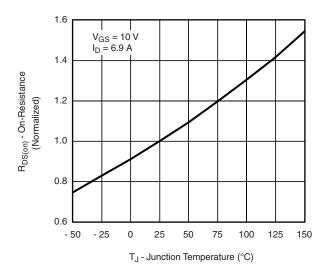
V_{GS} - Gate-to-Source Voltage (V)





V_{DS} - Drain-to-Source Voltage (V)

Capacitance



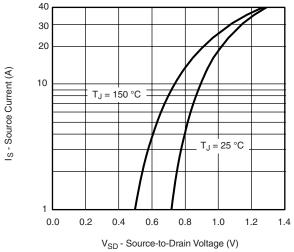
On-Resistance vs. Junction Temperature

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N-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless otherwise noted



R_{DS(on)} - On-Resistance(Ω) 0.04 $I_D = 6.9 A$ 0.02 0.00 6

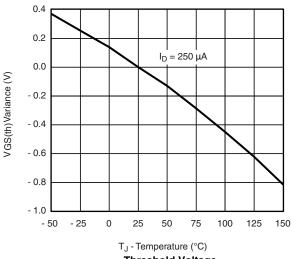
0.10

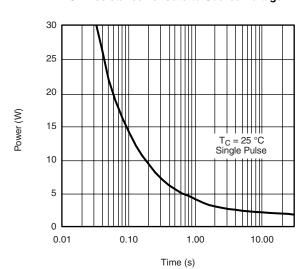
0.08

0.06

Source-Drain Diode Forward Voltage

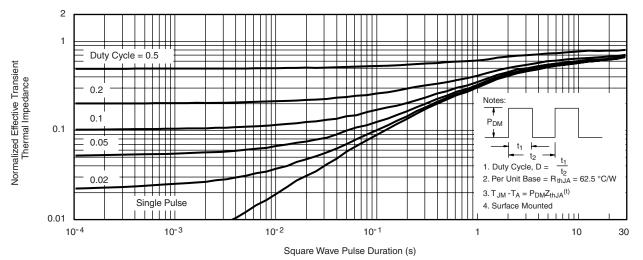
V_{GS} - Gate-to-Source Voltage (V) On-Resistance vs. Gate-to-Source Voltage





Threshold Voltage

Single Pulse Power

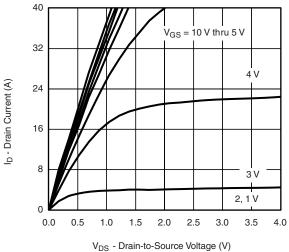


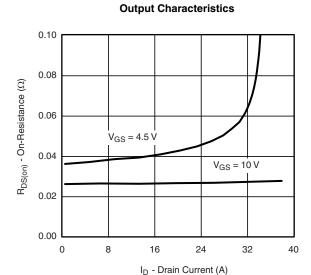
Normalized Thermal Transient Impedance, Junction-to-Ambient



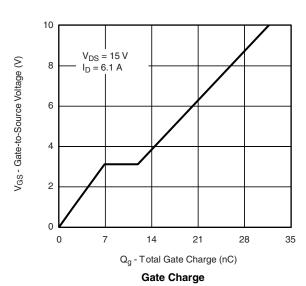


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless otherwise noted





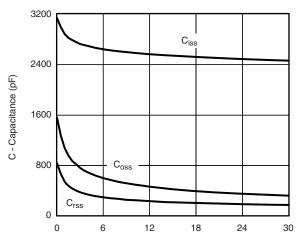
On-Resistance vs. Drain Current



 $T_C = -55$ 32 125 °C ID-Drain Current (A) 24 16 8 0 2 3 4 5

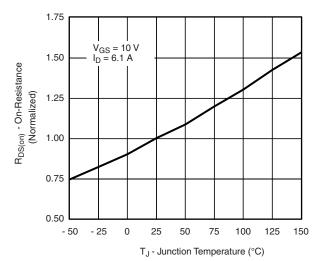
V_{GS} - Gate-to-Source Voltage (V)





V_{DS} - Drain-to-Source Voltage (V)

Capacitance

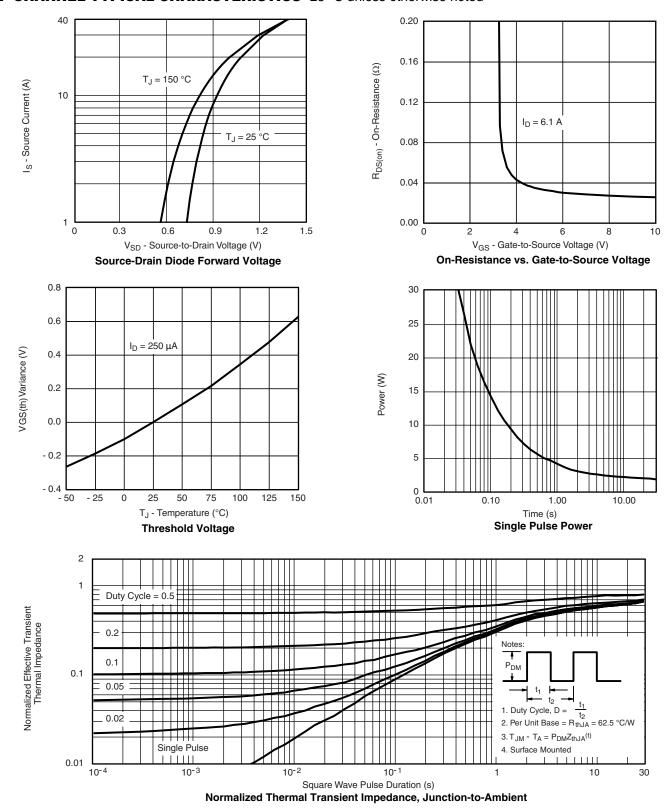


On-Resistance vs. Junction Temperature

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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless otherwise noted



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